



## CELCON® GB10

### **CELCON®**

Celcon® GB10 is a 10% glass bead filled grade for low shrinkage and warp resistance in large, flat, and thin walled parts. Chemical abbreviation according to ISO 1043-1: POM

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Product Information			
Resin Identification	POM-GB10		ISO 1043
Part Marking Code	>POM-GB10<		ISO 11469
Rheological properties			
Melt volume-flow rate	17	cm <sup>3</sup> /10min	ISO 1133
Temperature	190	°C	
Load	2.16	kg	
Melt mass-flow rate	22	g/10min	ISO 1133
Melt mass-flow rate, Temperature	190	-	
Melt mass-flow rate, Load	2.16		
Moulding shrinkage, parallel	1.9		ISO 294-4, 2577
Moulding shrinkage, normal	1.6	%	ISO 294-4, 2577
Typical mechanical properties			
Tensile modulus	2100	MPa	ISO 527-1/-2
Tensile modulus Tensile stress at yield, 50mm/min		MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min		%	ISO 527-1/-2
Tensile strain at break, 50mm/min	10		ISO 527-1/-2
Charpy notched impact strength, 23°C	-	kJ/m <sup>2</sup>	ISO 179/1eA
Poisson's ratio	0.37 <sup>[C]</sup>		10 0 11 0, 10 0
[C]: Calculated			
Thermal properties			
Melting temperature, 10°C/min	166	-	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	94	°C	ISO 75-1/-2
Dhysical/Other properties			
Physical/Other properties			
Density	1470	kg/m³	ISO 1183
Injection			
Drying Recommended	no		
Drying Temperature	100	°C	
Drying Time, Dehumidified Dryer	3 - 4		
Processing Moisture Content	≤0.2	%	
Melt Temperature Optimum	190	°C	
Min. melt temperature	180	°C	
Max. melt temperature	200		
Screw tangential speed	≤0.3		
Mold Temperature Optimum	105	°C	

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90 °C

120 °C

2 MPa

60 - 120 MPa

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Min. mould temperature

Max. mould temperature

Hold pressure range

Back pressure





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#### Characteristics

Processing Injection Moulding

Delivery form Pellets

Special characteristics Low Warpage

#### Additional information

Injection molding

#### Preprocessing

Drying is generally not required because Celcon® and Hostaform® acetal copolymers are not hydroscopic nor are they degraded by moisture during processing. Excessive moisture can lead to splay (silver streaking) in molded parts. For better uniformity in molding especially when using regrind or material that has been stored in containers open to the atmosphere, recommended drying conditions are 80 C (180 F) for 3hours. Desiccant hopper dryers are not required. Maximum water content = 0.35%

#### **Processing**

Standard reciprocating screw injection molding machines with a high compression screw (minimum 3:1 and preferably 4:1) and low back pressure (0.35 Mpa/50 PSI) are favored. Using a low compression screw (I.E. general purpose 2:1 compression ratio) can result in unmelted particles and poor melt homogeneity. Using a high back pressure to make up for a low compression ratio may lead to excessive shear heating and deterioration of the material.

Melt Temperature: Preferred range 182-199 C (360-390 F). Melt temperature should never exceed 230 C (450 F).

Mold Surface Temperature: Preferred range 82-93 C (180-200 F) especially with wall thickness less than 1.5 mm (0.060 in.). May require mold temperature as high as 120 C (250 F) to reproduce mold surface or to assure minimal molded in stress. Wall thickness greater than 3mm (1/8 in.) may use a cooler (65 C/150 F) mold surface temperature and wall thickness over 6mm (1/4 in.) may use a cold mold surface down to 25 C (80 F). In general, mold surface temperatures lower than 82 C (180 F) may hinder weld line formation and produce a hazy surface or a surface with flow lines, pits and other included defects that can hinder part performance.

#### Postprocessing

Postprocessing conditioning and moisturizing are not required. It may be necessary to fixture large or complicated parts with varying wall thickness to prevent warpage while cooling to ambient temperature.

Processing Notes Pre-Drying

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Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.

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